

ROHS EARTH FRIEND

OBSOLETE PRODUCT HMC189MS8E

GaAs MMIC SMT PASSIVE X2 FREQUENCY MULTIPLIER 2 - 4 GHz

Typical Applications

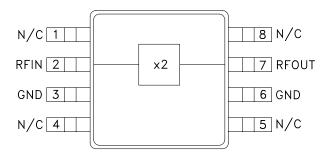
The HMC189MS8 / HMC189MS8E is suitable for:

- Wireless Local Loop
- LMDS, VSAT, and Point-to-Point Radios
- UNII & HiperLAN
- Test Equipment

Features

Conversion Loss: 13 dB Fo, 3Fo, 4Fo Isolation: 33 dB Input Drive Level: +10 to +15 dBm

Functional Diagram



General Description

The HMC189MS8 & HMC189MS8E are miniature passive frequency doublers in plastic 8-lead MSOP packages. The suppression of undesired fundamental and higher order harmonics is 33 dB typical with respect to input signal levels. The doubler uses the same diode/balun technology used in Hittite MMIC mixers. The doubler is ideal for high volume applications where frequency doubling of a lower frequency is more economical than directly generating a higher frequency. The passive Schottky diode doubler technology contributes no measurable additive phase noise onto the multiplied signal.

Electrical Specifications, $T_A = +25^{\circ}$ C, As a Function of Drive Level

	Input = +10 dBm		Input = +13 dBm			Input = +15 dBm				
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, Input	2.5 - 3.5		2.5 - 3.75		2 - 4		GHz			
Frequency Range, Output	5 - 7		5 - 7.5			4 - 8			GHz	
Conversion Loss		13	17		13	15		13	17	dB
FO Isolation (with respect to input level)	29	32		30	33		31	34		dB
3FO Isolation (with respect to input level)	37	43		35	42		33	40		dB
4FO Isolation (with respect to input level)	32	40		33	40		31	40		dB

For price, delivery and to place orders: Hittite Microwave Corporation, 2 Elizabeth Drive, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com Application Support: Phone: 978-250-3343 or apps@hittite.com

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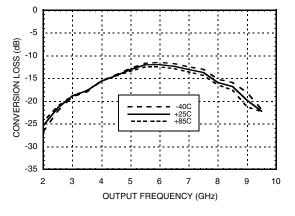
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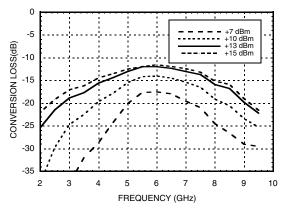
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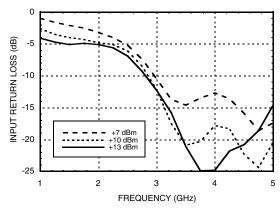
Conversion Loss @ +13 dBm Drive Level

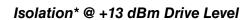


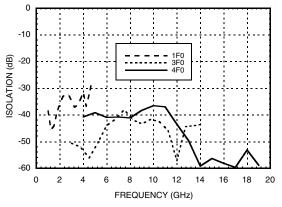
Conversion Loss vs. Drive Level



Input Return Loss vs. Drive Level

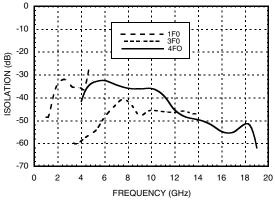






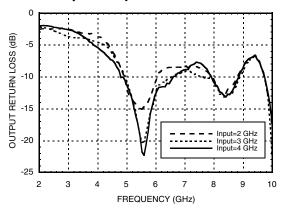
^{*} With respect to input level

Isolation* @ +10 dBm Drive Level



* With respect to input level

Output Return Loss for Several Input Frequencies



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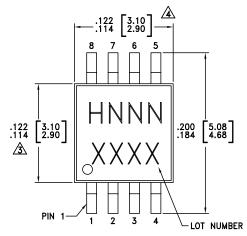
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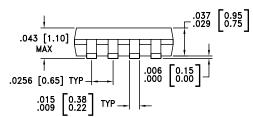
Absolute Maximum Ratings

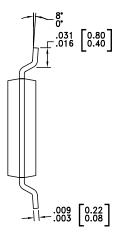
Input Drive	+27 dBm
Channel Temperature	150 °C
Continuous Pdiss (T= 85 °C) (derate 11.7 mW/°C above 85 °C)	0.76 W
Thermal Resistance (channel to ground paddle)	85.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



Outline Drawing







NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY

 $^{\rm 2.}_{\rm A}$ DIMENSIONS ARE IN INCHES [MILLIMETERS].

DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

4 DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.

5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]	
HMC189MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H189 XXXX	
HMC189MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H189</u> XXXX	

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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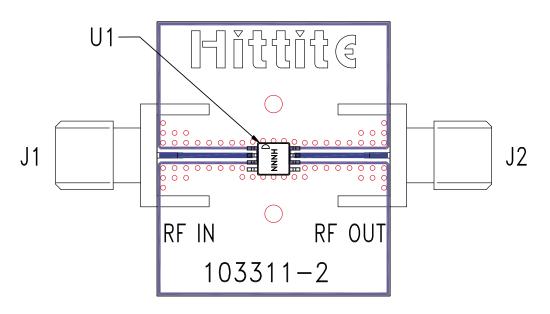


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Pin Description

Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8	N/C	These pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2	RFIN	Pin is DC coupled and matched to 50 Ohms from 2.0 to 4.0 GHz	
3, 6	GND	All ground leads must be soldered to PCB RF/DC ground.	
7	RFOUT	Pin is DC coupled and matched to 50 Ohms from 4.0 to 8.0 GHz	

Evaluation PCB



List of Materials for Evaluation PCB 103313 [1]

Item	Description
J1, J2	PCB Mount SMA Connector
U1	HMC189MS8 / HMC189MS8E Doubler
PCB [2]	103311 Eval Board

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

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